

1. Description

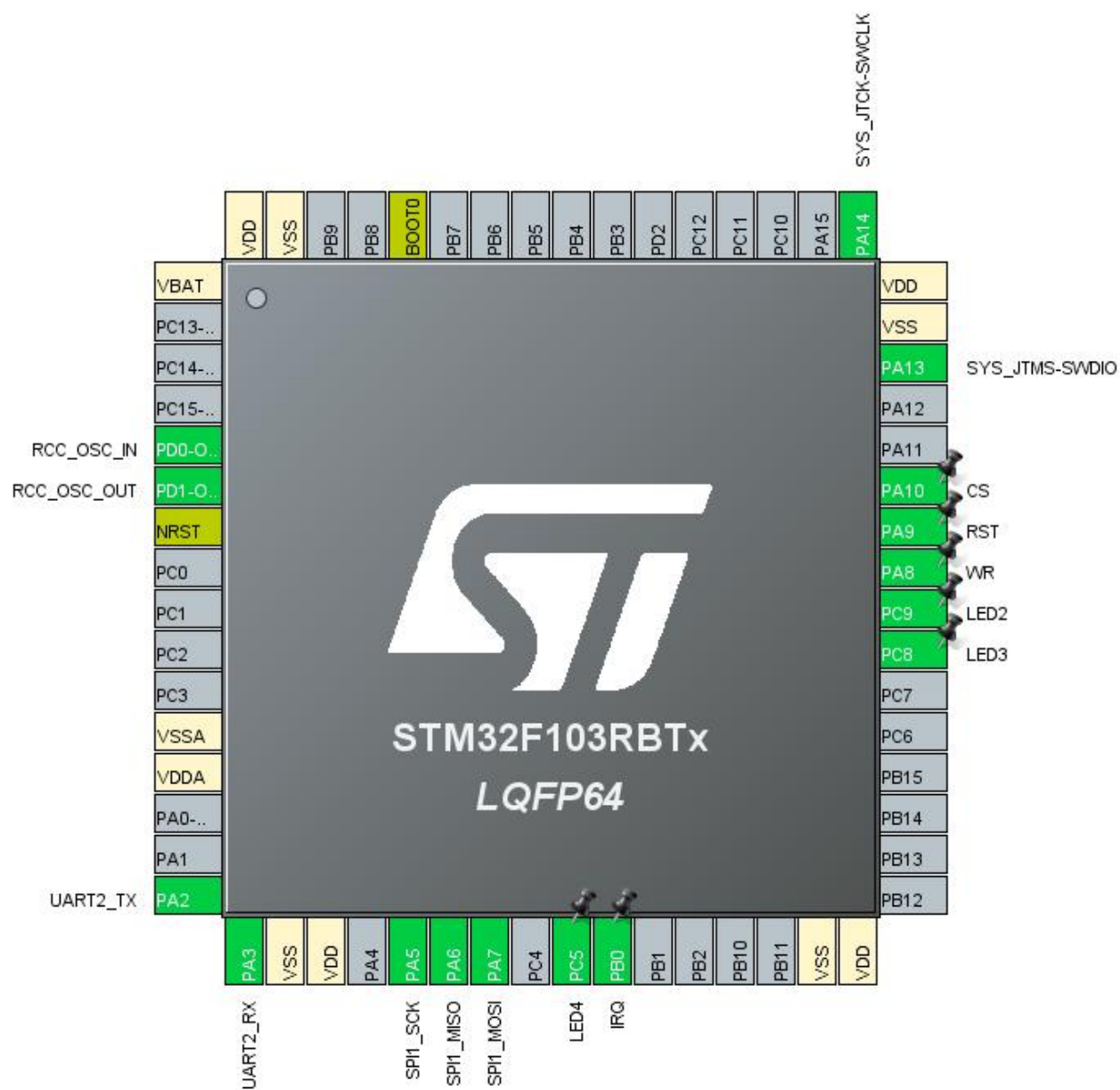
1.1. Project

Project Name	LD3320_Demo
Board Name	custom
Generated with:	STM32CubeMX 5.6.1
Date	07/01/2020

1.2. MCU

MCU Series	STM32F1
MCU Line	STM32F103
MCU name	STM32F103RBTx
MCU Package	LQFP64
MCU Pin number	64

2. Pinout Configuration



3. Pins Configuration

Pin Number LQFP64	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VBAT	Power		
5	PD0-OSC_IN	I/O	RCC_OSC_IN	
6	PD1-OSC_OUT	I/O	RCC_OSC_OUT	
7	NRST	Reset		
12	VSSA	Power		
13	VDDA	Power		
16	PA2	I/O	USART2_TX	UART2_TX
17	PA3	I/O	USART2_RX	UART2_RX
18	VSS	Power		
19	VDD	Power		
21	PA5	I/O	SPI1_SCK	SPI1_SCK
22	PA6	I/O	SPI1_MISO	SPI1_MISO
23	PA7	I/O	SPI1_MOSI	SPI1_MOSI
25	PC5 *	I/O	GPIO_Output	LED4
26	PB0	I/O	GPIO_EXTI0	IRQ
31	VSS	Power		
32	VDD	Power		
39	PC8 *	I/O	GPIO_Output	LED3
40	PC9 *	I/O	GPIO_Output	LED2
41	PA8 *	I/O	GPIO_Output	WR
42	PA9 *	I/O	GPIO_Output	RST
43	PA10 *	I/O	GPIO_Output	CS
46	PA13	I/O	SYS_JTMS-SWDIO	
47	VSS	Power		
48	VDD	Power		
49	PA14	I/O	SYS_JTCK-SWCLK	
60	BOOT0	Boot		
63	VSS	Power		
64	VDD	Power		

* The pin is affected with an I/O function



5. Software Project

5.1. Project Settings

Name	Value
Project Name	LD3320_Demo
Project Folder	E:\project\LD3320 Board\LD3320_Board_code\STM32\LD3320_Demo
Toolchain / IDE	MDK-ARM V5.27
Firmware Package Name and Version	STM32Cube FW_F1 V1.8.0

5.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy all used libraries into the project folder
Generate peripheral initialization as a pair of '.c/.h' files	Yes
Backup previously generated files when re-generating	No
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power consumption)	No

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32F1
Line	STM32F103
MCU	STM32F103RBTx
Datasheet	13587_Rev17

6.2. Parameter Selection

Temperature	25
Vdd	3.3

6.3. Battery Selection

Battery	Li-SOCL2(A3400)
Capacity	3400.0 mAh
Self Discharge	0.08 %/month
Nominal Voltage	3.6 V
Max Cont Current	100.0 mA
Max Pulse Current	200.0 mA
Cells in series	1
Cells in parallel	1

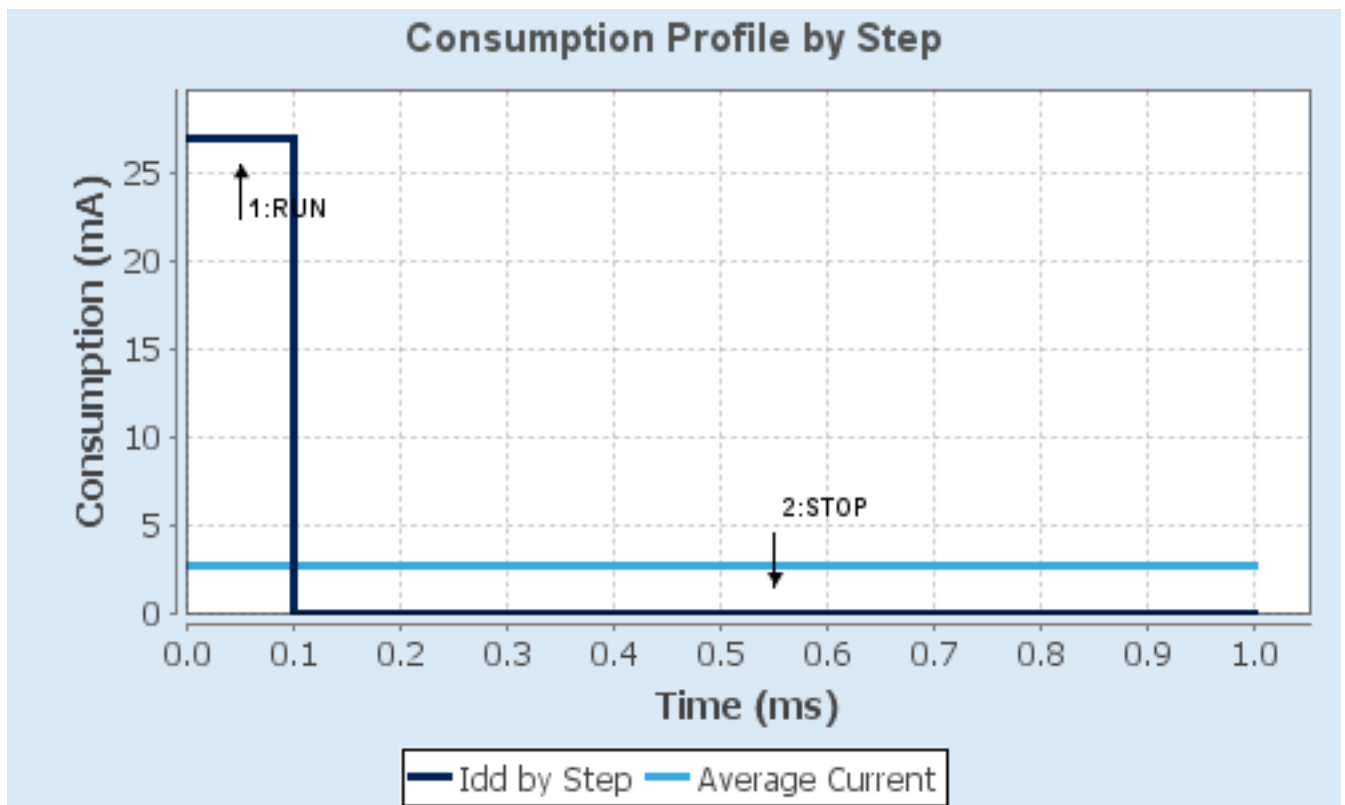
6.4. Sequence

Step	Step1	Step2
Mode	RUN	STOP
Vdd	3.3	3.3
Voltage Source	Battery	Battery
Range	No Scale	No Scale
Fetch Type	FLASH	n/a
CPU Frequency	72 MHz	0 Hz
Clock Configuration	HSE PLL	Regulator LP
Clock Source Frequency	8 MHz	0 Hz
Peripherals		
Additional Cons.	0 mA	0 mA
Average Current	27 mA	14 μ A
Duration	0.1 ms	0.9 ms
DMIPS	90.0	0.0
Ta Max	100.99	105
Category	In DS Table	In DS Table

6.5. RESULTS

Sequence Time	1 ms	Average Current	2.71 mA
Battery Life	1 month, 21 days, 17 hours	Average DMIPS	61.0 DMIPS

6.6. Chart



7. IPs and Middleware Configuration

7.1. GPIO

7.2. RCC

High Speed Clock (HSE): Crystal/Ceramic Resonator

7.2.1. Parameter Settings:

System Parameters:

VDD voltage (V)	3.3
Prefetch Buffer	Enabled
Flash Latency(WS)	2 WS (3 CPU cycle)

RCC Parameters:

HSI Calibration Value	16
HSE Startup Timeout Value (ms)	100
LSE Startup Timeout Value (ms)	5000

7.3. SPI1

Mode: Full-Duplex Master

7.3.1. Parameter Settings:

Basic Parameters:

Frame Format	Motorola
Data Size	8 Bits
First Bit	MSB First

Clock Parameters:

Prescaler (for Baud Rate)	64 *
Baud Rate	1.125 MBits/s *
Clock Polarity (CPOL)	High *
Clock Phase (CPHA)	1 Edge

Advanced Parameters:

CRC Calculation	Disabled
NSS Signal Type	Software

7.4. SYS

Debug: Serial Wire

Timebase Source: SysTick

7.5. USART2

Mode: Asynchronous

7.5.1. Parameter Settings:

Basic Parameters:

Baud Rate	115200
Word Length	8 Bits (including Parity)
Parity	None
Stop Bits	1

Advanced Parameters:

Data Direction	Receive and Transmit
Over Sampling	16 Samples

* User modified value

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PD0-OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PD1-OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SPI1	PA5	SPI1_SCK	Alternate Function Push Pull	n/a	High *	SPI1_SCK
	PA6	SPI1_MISO	Input mode	No pull-up and no pull-down	n/a	SPI1_MISO
	PA7	SPI1_MOSI	Alternate Function Push Pull	n/a	High *	SPI1_MOSI
SYS	PA13	SYS_JTMS-SWDIO	n/a	n/a	n/a	
	PA14	SYS_JTCK-SWCLK	n/a	n/a	n/a	
USART2	PA2	USART2_TX	Alternate Function Push Pull	n/a	High *	UART2_TX
	PA3	USART2_RX	Input mode	No pull-up and no pull-down	n/a	UART2_RX
GPIO	PC5	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	LED4
	PB0	GPIO_EXTI0	External Interrupt Mode with Falling edge trigger detection	Pull-up *	n/a	IRQ
	PC8	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	LED3
	PC9	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	LED2
	PA8	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	WR
	PA9	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	RST
	PA10	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	CS

8.2. DMA configuration

nothing configured in DMA service

8.3. NVIC configuration

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable interrupt	true	0	0
Hard fault interrupt	true	0	0
Memory management fault	true	0	0
Prefetch fault, memory access fault	true	0	0
Undefined instruction or illegal state	true	0	0
System service call via SWI instruction	true	0	0
Debug monitor	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
EXTI line0 interrupt	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash global interrupt	unused		
RCC global interrupt	unused		
SPI1 global interrupt	unused		
USART2 global interrupt	unused		

* User modified value

9. Predefined Views - Category view : Current

10. Software Pack Report